

Product Name: ZX122S2BMPS PCISIG M.2 Socket 2 Key B-M passive breakout adapter-power measurement module – Page 1 of 3

Product Description: ZX122S2BMPS is PCISIG M.2 breakout adapter providing access to all PCISIG signals as well as providing method of power supplies test and measurement. ZX122S2BMPS is breakout adapter to be used for :

- 1- Test and measurement for signal quality, characterization , test and debug of any PCISIG signals via onboard 0405 SMD shunt landing pads.

a) Each PCISIG (excluding GND signals) are routed to 0402 SMD shunt package for easy probe access.

b) Each 0402 SMD shunt package may be wired for signal measurement via scope / test equipment.

c) Each 0402 SMD shunt package may be cut and redirected to another signal (onboard or offboard) for test and debug.

2- Measure and analyze power supply ripple, transients, Device Under Test, DUT, power consumption and more.

a) Each power supply rail is designed with current sensing power resistor, please see block diagram.

b) Utilizing scope probe – test equipment , measure power supply noise, ripples, transients, and DUT power consumption.

c) Utilizing eLoad (Electronic Load) , qualify host's power supply & maximum output power.

d) Identify power supply trace impedance, Rdc , for improved Host / DUT PCB design.

ZX122S2BMPS features:

1- Provides access to ALL PCISIG signals via onboard 0402 SMD shunt packages

2- Onboard current sense resistors for all supply rails – Please see table 1 for details.

3- Listed number adjacent to each 0402 SMD shunt package represents the associated PCISIG M.2 connector's pin number.

4- All traces are 50 Ohms impedance controlled.

5- Four layers PCB design, inner layers are GND planes.

6- Accessible GND exposed copper, enabling for ease of access for test and measurement.

7- Mates with any key matching M.2 Host and Device / DUT

8- ZX122S2BMPS-B converts host M.2 Key M interface to M.2 Key B module (DUT).

9- ZX122S2BMS-M converts host M.2 Key B interface to M.2 Key M module (DUT).

10- The module is shipped with 12pc of probing wires , ZX00BC2PH30 , See ordering information , ZX00BC2PH30 Zebax.com

Electrical: Insertion loss > -2dB @6GHz
Trace impedance: 50 Ω
Operating Temperature: -65°C to +170°C
M.2 Edge Connector type (J1) : Key B-M
Mates with: M.2 Key BM
Plating: Gold 100U
M.2 Receptacle (J2) :
Key Type: Key BM
Height: 0.16" (4.2mm)
Spacer : 0.1" (2.54mm) – See Figure 3
Plating: Gold 100U
Current per pin: 0.5A (maximum)

Current Sense:
R1, R2 : 10mΩ 2512 SMD 7W - Thickness: 0.02" (0.5mm) Max - See Figure 3
Ratings: AEC-Q200
Temperature Coefficient: ±75ppm / °C
Operating Temperature:-65°C to +85°C at 100% listed power rating, see Table 1
-65°C to +170°C see section Power Rating on page 3

Shunt:
Package: 0402 SMD

Current Sense resistors: Table 1 lists onboard ZX122S2BMPS current sense resistors and associated PCISIG M.2 connector assignment

Table 1

Current Sense Resistor	PCISIG M.2 Connector pin number	PCISIG M.2 Supply Rail	Description	Package	
				(inch)	(mm)
R1	2, 4,	3.3 V	10m Ohms 1% 7W	2512	6432
R2	70, 72, 74	3.3 V	10m Ohms 1% 7W	2512	6432

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Figure 2 – Circuit diagram

Shunt 0402 SMD package 0 Ω
50 Ω : All traces are designed 50 Ω trace impedance control
J2 : PCISIG M.2 receptacle connector for the ZX122S2BMPS

Figure 1 – ZX122S2BMPS Block diagram

R1,R2 : current sense 3.3Vat resistor
51 .. 54 PCISIGN connector pin number routed to the 0402 SMD shunts.

Note 1 : ZX122S2BMPS is offered with M.2 Receptacle (J2) Key B or Key M.
ZX122S2BMPS-B Converts M.2 Key M host to M.2 Key B module interface.
ZX122S2BMPS-M Converts M.2 Key B host to M.2 Key M module interface.

ZX122S2BMPS package includes:

Part number	PCB Edge	J2	Quantity	Description
ZX122S2BMPS-B	Key BM	Key B	1	M.2 PCISIG Socket 2 Key BM module, see Note 1
ZX122S2BMPS-M	Key BM	Key M	1	M.2 PCISIG Socket 2 Key BM module, see Note 1
ZX00BC2PH30			12	32AWG Bare Copper wire to pin header wire assembly

ZX00BC2PH30 site page for ordering ZX00BC2PH30 wire assembly

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SPECIFIED DIMENSIONS
ARE INCHES (MM).
ROHS COMPLIANT

ASSEMBLY DRAWING

ITEM: ZX122S2BMPS

DESCRIPTION: PCISIG M.2 NGFF Socket 2 Key B-M-y passive breakout adapter power measurement module

CHECKED:
M. MARINA

DRAWN:
MATTHEW CT

REVISION: 1.0
SHEET: 1 OF 3

Current Sense resistors: The current sense resistors may be removed if external electronic load , eLoad, is used. eLoad test equipment may be applied to ZX122S2BMPS for power supply characterization , test and measurements. Eload suppliers : BK Precision , Chroma, Instek , Kikusui and more

Signal assignments: Table 2 exhibits the routed M.2 PCISIG signals on the ZX122S2BMPS module.

1- Table 2 represents only the PCISIG M.2 Socket 2 Key BM power supply and the assigned GND , PCISIG M.2 reference ground, signal assignments for “Socket 2 Key BM” applications.

2- Table 2 represents only the PCISIG M.2 Socket 2 Key BM signal assignments for the listed application. However; **there are other PCISIG** signal assignment for the M.2 Socket 2 Key BM design configuration. All PCISIG M.2 assigned Power Supply rails and GND reference M.2 pin assignments are identical across PCISIG M.2 Socket 2 Key BM solutions. Please apply your design signal name convention to non-power supply rail signals as the listed signal names on the Table 1 applies to the listed specific M.2 application.

Ground / Exposed Copper :
All of the PCISIG M.2 GND , reference ground , signals are connected to each other along with the 2 inner GND planes. In addition; the exposed copper on the ZX122S2BMPS is the module’s GND for purpose of rework and probing purpose.

PCISIG M.2 signals :
ZX122S2BMPS passes through all PCISIG M.2 signals (excluding the power supply rails . All traces are 50 Ohms impedance controlled. ZX122S2BMPS passes through the reserved “NC” No Connect signals as well.

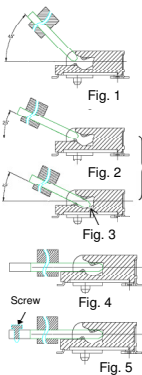
Application: Bringup, testing, emulation, development, modular design evaluations
M.2 PCISIG Socket power supply test characterization
SDIO SSD SATA WWAN DP WIFI GPS GYRO Compass BT FM sensor module
Socket 2 Add-in Card Key BM-E , Socket 2 DisplayPort Key BM , Socket 2 SDIO Key E
Socket 2 WWAN Key C , Socket 2 PCIe-based SSD Key B-M , Socket 2 SATA-based SSD Key B-M
Socket 2 PCIe / USB 3.1 Gen1-Based WWAN Key B , Socket2 PCIe-Based WWAN Key B
Socket 2 USB3.1 Gen1-based WWAN Key B , Socket 2 SSIC WWAN Key B
Socket 3 PCIe-based Key M , Socket 3 SATA-based Key M

Mates with : Any standard M.2 NGFF PCISIG connector on host and device Key BM
TE 2199125 2199119 2199230 2199133 JAE SM3ZS067
Bellwether: SD-80148 SD-80149 SD-80152 SD-80159 Amphenol

Module Insertion, Removal process:

In order to avoid any mechanical stress or damage to ZX122S2BMPS, please follow the below listed guidelines for insertion and removal process:

- 1- Move the Module against the housing chamber, see figure 1
- 2- Rotate module to 25°, insert it until the module surface reaches the ramp, figure 2, 3
- 3- Rotate the module to horizontal position, see figure 4
- 4- Fix the module by screw, see figure 5



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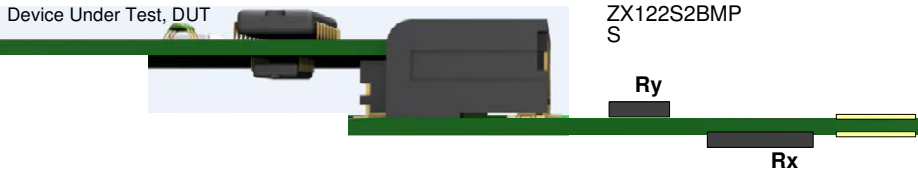


Figure 4 – Typical application - Rx, Ry : Current sense resistors

Table 2 – PCISIG M.2 Socket 2 Key BM

Table 2 represents only the PCISIG M.2 Socket 2 Key BM power supply and the assigned GND , PCISIG M.2 reference ground, signal assignments for “Socket 2 Key BM” applications.

Socket 2 PCIe-based SSD Key B-M						
Signal	PCISIG M.2 connector pin				Signal	
	Pin	ZX122S2BMPS		Pin		
		Label ¹				
3.3 V	74	R2 ²		75	75	CONFIG_2 = GND
3.3 V	72			73	73	VIO_CFG (O)
3.3 V	70				71	GND
SUSCLK (I)(0/1.8V/3.3V)	68	68		69	69	CONFIG_1 = NC
ADD-IN CARD KEY M	66	66		67	67	NC
	64	64		65	65	ADD-IN CARD KEY M
	62	62		63	63	
	60	60		61	61	
Reserved for MFG_CLOCK	58	58		59	59	
Reserved for MFG_DATA	56	56			57	GND
PEWAKE# (I/O)(0/1.8V/3.3V)	54	54		55	55	REFCLKp
CLKREQ# (I/O)(0/1.8V/3.3V)	52	52		53	53	REFCLKn
PERST# (I)(0/1.8V/3.3V)	50	50			51	GND
NC	48	48		49	49	PERp0
NC	46	46		47	47	PERn0
ALERT# (O)(0/1.8V)	44	44			45	GND
SMB_DATA (I/O)(0/1.8V)	42	42		43	43	PETp0
SMB_CLK (I/O)(0/1.8V)	40	40		41	41	PETn0
NC	38	38			39	GND
NC	36	36		37	37	PERp1
NC	34	34		35	35	PERn1
NC	32	32			33	GND
NC	30	30		31	31	PETp1
PLA_S2# (O) (0/1.8V))	28	28		29	29	PETn1
NC	26	26			27	GND
NC	24	24		25	25	NC
NC	22	22		23	23	NC
NC	20	20		21	21	CONFIG_0 = GND
ADD-IN CARD KEY B	18	18		19	19	ADD-IN CARD KEY B
	16	16		17	17	
	14	14		15	15	
	12	12		13	13	
LED_1# (O)(OD)	10	10		11	11	NC
PLN# (I) (O/1.8V/3.3V)	8	8		9	9	NC
NC	6	6		7	7	NC
3.3 V	4	R1 ²		5	5	NC
3.3 V	2				3	GND
				1	1	CONFIG_3 = GND

Note 1: *Label* is the labled number on the adjacent 0402 SMD shunt package on the ZX122S2BMPS module. The listed signal name in table 2 may vary depending to your M.2 design configuration. Please apply your design signal name convention to non-power supply rail signals & GND.
2: The supply power is available on the listed current sense resistor.

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ITEM: ZX122S2BMPS

DESCRIPTION: PCISIG M.2 NGFF Socket 2 Key B-M passive breakout adapter power measurement module

CHECKED:
M. MARINA

DRAWN:
MATTHEW CT

REVISSION: 1.0
SHEET: 2 OF 3

Typical Application: ZX122S2BMPS is designed for purpose of PCISIG M.2 power supply characterization, test and debug at full connector’s bandwidth. It provides onboard current sense resistors where scope probe could be utilized for measuring characterization data for qualifying the host or device functional behavior. Additionally, the current sense resistors may be replaced by eLoad for transient and dynamic load throttling. Below are few suggestions in respect to proper power supply measurements using ZX122S2BMPS module:

Scope Probe wire Installation:

Utilize the supplied ZX00BC2PH30 bare copper to pin wire assembly whenever possible – Based on availability of type of scope + probing options, install probe wire as listed below

- 1- It is recommended to keep the +probe wire length at 0.5" (1.2cm) long.
- 2- In order to avoid ground loop problems, please use the shortest Ground probe wire interfacing to the nearest GND reference. ZX122S2BMPS provides several exposed copper test points for probing purpose.
- 3- Ensure scope probe’s bandwidth is set at 20MHz – Certain tests require full scope + scope probe bandwidth; however , industry standard is 20MHz bandwidth for power supply test and measurements.
- 3- Both Keysight as well as Tektronix offer variety of single ended as well as differential probes along with their accessories, below are few probes from each vendor:
 - a) Keysight differential probe or similar N2795A, N2796A, 1168V, 1134B along with E2677B differential Solder-in probe, N5426A ZIF Tip, N2884A Fine Wire ZIF Tip and more – See the figure “probe head accessories”.
 - b) Tektronix offers several single-ended as well as differential probes such as : P6243, P6245, P6248, P6246, P6247 or any TP1500, TAP2500, TAP3500, TAP4000, P7240 of TDP7000 series or equivalent
- 4- Please follow your vendor’s guideline in installation of probe wires & accessories.

Power Rating : Onboard current sense resistors on ZX122S2BMPS module are designed for maximum power consumption per PCISIG M.2 specification operating within -65°C to 85°C temperature range. The current sense resistor’s power rating will degrade at above 85°C test environment. It is highly recommended to utilize external cooling fan if your design expects to exceed maximum current via each PCISIG M.2 pin (0.5A per pin) at **above 85°C** test environment.

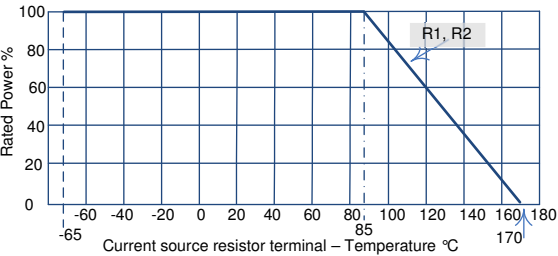
The onboard current sense resistors operate at 100% listed power ratings (see Table 1) within temperature range :
R1, R2 : -65°C ≤ operating temperatures ≤ 85°C with tolerance = ±1%

The onboard current sense resistors **power ratings** derail at **above 85°C**. Figure 4 exhibits the current sense resistors derating curve.
Current sense resistors rated power ; $P = VI = I^2 \times R$ where I is the maximum current for the listed resistor value R

Below are few suggestions, if your test & measurement environment falls ≥ **+85°C** temperature range :

- 1- Apply cooling fan where the current sense resistor’s terminal blocks are measured at 85°C – Please note - The ZX122S2BMPS module design provides heatsink solution to the onboard current sense resistors via inner layers thermal distribution method.
- 2- Replace the onboard current sense resistors with lower values (similar footprint), resulting at higher power ratings at ≥ 85°C test environment.
- 3- Replace onboard current sense resistors with eLoad (electronic Load Board / System) – eLoad system resides outside of test chamber, therefore it is not subject to temperature degradation.

Figure 4 – Current sense resistor Derating chart

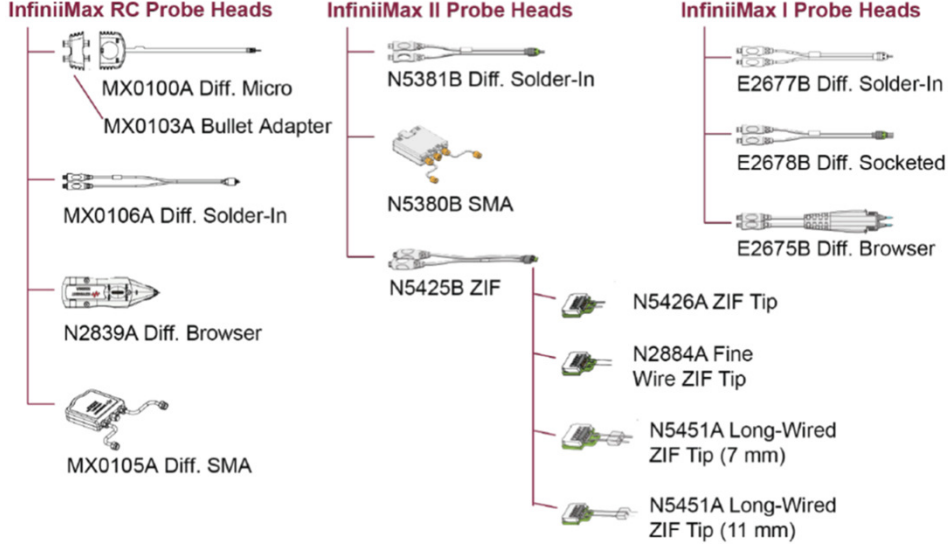


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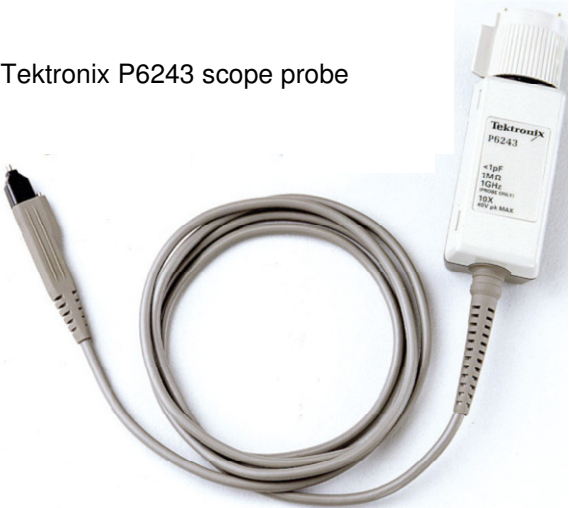
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Keysight Probe Head accessories



Tektronix P6243 scope probe



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